PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
HUNG-SEN WANG	06/10/2020
YUN-TA TSAI	06/04/2020
RUEY-HSIN LIU	06/04/2020
SHIH-FEN HUANG	06/04/2020
HO-CHUN LIOU	06/10/2020

RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY LTD.	
Street Address:	NO.8, LI-HSIN RD. 6, HSINCHU SCIENCE PARK	
City:	HSINCHU	
State/Country:	TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16906894

CORRESPONDENCE DATA

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SIGNATURE:	/Anthony King/	
DATE SIGNED:	06/19/2020	

Total Attachments: 2

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PATENT 506116442 REEL: 052993 FRAME: 0064

ASSIGNMENT

WHEREAS, I(we), WANG, HUNG-SEN, TSAI, YUN-TA, LIU, RUEY-HSIN, HUANG, SHIH-FEN and LIOU, HO-CHUN whose post office address(es) appear(s) below, hereinafter referred to as ASSIGNOR, have invented certain new and useful invention entitled

HIGH VOLTAGE DEVICE (hereinafter referred to as the INVENTION) for which an amplication for United States Latters Patent (Utility Potent

s executed on even date herewith unl United States Design Patent v		o withwart.	
☐ executed on:			
☐ filed on:	Serial No.:		
a established by PCT Internation	nal Patent Application No.:	filed:	designating the
Inited States of America	•		and the second s
🗖 issued on	as U.S. Patent No.:		

WHEREAS, TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY LTD. whose post office address is NO.8, LI-HSIN RD. 6, HSINCHU SCIENCE PARK, HSINCHU, TAIWAN, R.O.C. hereinafter referred to as ASSIGNEE, is desirous of acquiring the entire right, title and interest in and to the same in the United States and its territorial possessions;

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, I (we), ASSIGNOR, by these presents do sell, assign and transfer unto said ASSIGNEE, the entire right, title, and interest in and to said INVENTION and application throughout the United States of America, including any and all Letters Patent granted on any division, continuation, continuation-in-part and reissue of said application for the full term or terms for which the same may be granted, including all priority rights under any International Convention.

ASSIGNOR further covenants that no assignments, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment;

ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent application(s) in the United States for said INVENTION, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said INVENTION, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE'S expense, to identify and communicate to ASSIGNEE at ASSIGNEE'S request documents and information concerning the INVENTION that are within ASSIGNOR'S possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance, litigation and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR'S obligations under this instrument shall extend to ASSIGNOR'S heirs, executors, administrators and other legal representatives.

ALSO. ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all Letters Patent referred to above to ASSIGNEE, as the ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE'S sole use and behoof; and for the use and behoof of ASSIGNEE'S legal representatives and successors, to the full end of the term for which such Letters Patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

Assignor Name WANG, HUNG-SEN	Address 5E. NO.1, WENHUA 2ND ST., EAST DIST., TAINAN CITY 701, TAIWAN (R.O.C.)
Signature of Assignory (X) WANG, HUNG-SEO	Dute of Signature (X) >>>> ob, 10
Name of Witness (optional)	Name of Witnexs (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

Assignor Name TSAI, YUN-TA	Address 5E., NO.105, LN. 28, SEC. 1, TIEDAO RD., EAST DIST., HSINCHU CITY 30059, TAIWAN (R.O.C.)
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Signature of Witness (optional)	Signature of Witness (Optional)
Assignor Name LIU, RUEY-HSIN	5F-3, NO. 56, UNIVERSITY ROAD, HSINCHU CITY, TAIWAN (R.O.C.)
Signature of Assigner (X) LIX RASY HSW	Dute of Signature (X) -2020 O Q
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)
Assignor Name HUANG, SHIH-FEN	18F. NO. 296-1, EAST SEC. 1, KUANG-MING ROAD 6, JHUBEI CITY, HSINCHU COUNTY, TAIWAN (R.O.C.)
Signature & Abigaly (X)	Date of Signature (X) 06/04/>020
Name of Witness (optional)	Name of Witness (aptional)
Signature of Witness (optional)	Signature of Wimess (Optional)
Assignor Name LIOU, HO-CHUN	Address 4E3, NO.82, DAXUE RD., EAST DIST., HSINCHU CITY 300, TAIWAN (R.O.C.)
Signature of Assignar (X)	Date of Signature (X) 06//0/2420
Name of Witness (optional)	Name of Witness (optimal)

Signature of Witness (Optional)

Signature of Witness (optional)